2-Bit 100 Mb/s Configurable Dual-Supply Level Translator

The NLSX5012 is a 2-bit configurable dual-supply autosensing bidirectional level translator that does not require a direction control pin. The I/O V_{CC}- and I/O V_L-ports are designed to track two different power supply rails, V_{CC} and V_L respectively. Both the V_{CC} and the V_L supply rails are configurable from 0.9 V to 4.5 V. This allows a logic signal on the V_L side to be translated to either a higher or a lower logic signal voltage on the V_{CC} side, and vice-versa.

The NLSX5012 offers the feature that the values of the V_{CC} and V_L supplies are independent. Design flexibility is maximized because V_L can be set to a value either greater than or less than the V_{CC} supply. In contrast, the majority of competitive auto sense translators have a restriction that the value of the V_L supply must be equal to less than (V_{CC} - 0.4) V.

The NLSX5012 has high output current capability, which allows the translator to drive high capacitive loads such as most high frequency EMI filters. Another feature of the NLSX5012 is that each I/O_V_{Ln} and I/O_V_{CCn} channel can function as either an input or an output.

An Output Enable (EN) input is available to reduce the power consumption. The EN pin can be used to disable both I/O ports by putting them in 3-state which significantly reduces the supply current from both V_{CC} and V_L . The EN signal is referenced to the V_L supply.

Features

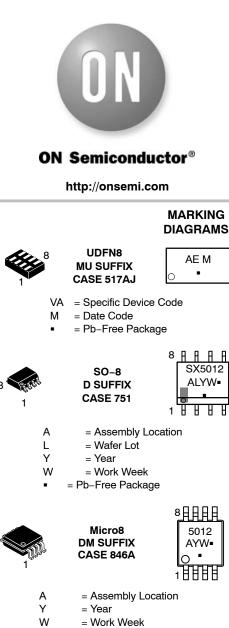
- Wide V_{CC}, V_L Operating Range: 0.9 V to 4.5 V
- V_L and V_{CC} are independent
 V_L may be greater than, equal to, or less than V_{CC}
- High 100 pF Capacitive Drive Capability
- High–Speed with 140 Mb/s Guaranteed Date Rate for V_{CC}, V_L > 1.8 V
- Low Bit-to-Bit Skew
- Overvoltage Tolerant Enable and I/O Pins
- Non-preferential Power-Up Sequencing
- Power-Off Protection
- Small packaging: UDFN8, SO-8, Micro8
- These are Pb-Free Devices

Typical Applications

• Mobile Phones, PDAs, Other Portable Devices

Important Information

- ESD Protection for All Pins:
 - HBM (Human Body Model) > 8000 V



= Pb–Free Package

ORDERING INFORMATION

Device	Package	Shipping [†]
NLSX5012MUTAG	UDFN8 (Pb-Free)	3000/Tape & Reel
NLSX5012DR2G	SO-8 (Pb-Free)	2500/Tape & Reel
NLSX5012DMR2G	Micro8 (Pb-Free)	4000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

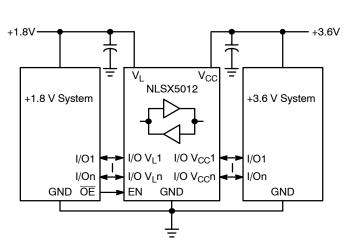


Figure 1. Typical Application Circuit

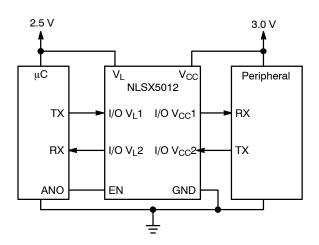


Figure 3. Application Example for $V_L < V_{CC}$

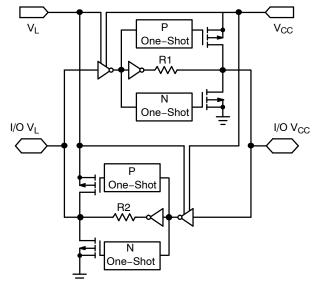


Figure 2. Simplified Functional Diagram (1 I/O Line)

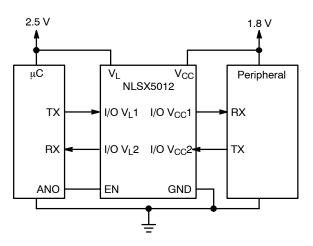


Figure 4. Application Example for $V_L > V_{CC}$

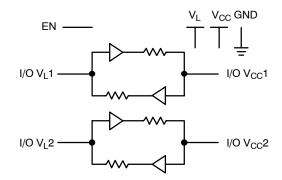
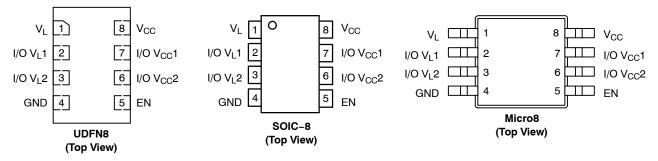


Figure 5. Logic Diagram





PIN ASSIGNMENT

Pins Description	
V _{CC}	V _{CC} Input Voltage
VL	V _L Input Voltage
GND	Ground
EN	Output Enable
I/O V _{CC} n	I/O Port, Referenced to V _{CC}
I/O V _L n	I/O Port, Referenced to VL

FUNCTION TABLE

EN	Operating Mode
L	Hi–Z
Н	I/O Buses Connected

MAXIMUM RATINGS

Symbol	Parameter	Value	Condition	Unit
V _{CC}	High-side DC Supply Voltage	-0.5 to +5.5		V
VL	Low-side DC Supply Voltage	-0.5 to +5.5		V
I/O V _{CC}	V _{CC} –Referenced DC Input/Output Voltage	-0.5 to +5.5		V
I/O V _L	V _L -Referenced DC Input/Output Voltage	-0.5 to +5.5		V
VI	Enable Control Pin DC Input Voltage	-0.5 to +5.5		V
I _{IK}	DC Input Diode Current	-50	V _I < GND	mA
I _{OK}	DC Output Diode Current	-50	V _O < GND	mA
I _{CC}	DC Supply Current Through V _{CC}	±100		mA
۱L	DC Supply Current Through VL	±100		mA
I _{GND}	DC Ground Current Through Ground Pin	±100		mA
T _{STG}	Storage Temperature	-65 to +150		°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter		Min	Max	Unit
V _{CC}	High-side Positive DC Supply Voltage		0.9	4.5	V
VL	Low-side Positive DC Supply Voltage		0.9	4.5	V
VI	Enable Control Pin Voltage		GND	4.5	V
V _{IO}	Bus Input/Output Voltage	I/O V _{CC} I/O V _L	GND GND	4.5 4.5	V
T _A	Operating Temperature Range		-55	+125	°C
$\Delta t / \Delta V$	Input Transition Rise or Rate V _I , V _{IO} from 30% to 70% of V _{CC} ; V _{CC} = 3.3 V \pm 0.3 V		0	10	ns

DC ELECTRICAL CHARACTERISTICS

		Test Conditions (Note 1)	V _{CC} (V) (Note 2)	V _L (V) (Note 3)	-4	0°C to +85	°C	–55°C to		
Symbol	Parameter				Min	Typ (Note 4)	Max	Min	Max	Unit
V _{IHC}	I/O V _{CC} Input HIGH Voltage		0.9-4.5	0.9-4.5	2/3 * V _{CC}	-	-	2/3 * V _{CC}	-	V
V _{ILC}	I/O V _{CC} Input LOW Voltage		0.9-4.5	0.9-4.5	-	-	1/3 * V _{CC}	-	1/3 * V _{CC}	V
V _{IHL}	I/O V _L Input HIGH Voltage		0.9-4.5	0.9-4.5	2/3 * VL	_	-	2/3 * V _L	-	V
V _{ILL}	I/O V _L Input LOW Voltage		0.9-4.5	0.9-4.5	-	-	1/3 * VL	-	1/3 * V _L	V
V _{IH}	Control Pin Input HIGH Voltage	T _A = +25°C	0.9 – 4.5	0.9 - 4.5	2/3 * V _L	-	_	2/3 * V _L	-	V
V_{IL}	Control Pin Input LOW Voltage	T _A = +25°C	0.9-4.5	0.9 - 4.5	-	-	1/3 * VL	_	1/3 * V _L	V
V _{OHC}	I/O V _{CC} Output HIGH Voltage	I/O V _{CC} source current = 20 μA	0.9-4.5	0.9-4.5	0.9 * V _{CC}	-	_	0.9 * V _{CC}	-	V
V _{OLC}	I/O V _{CC} Output LOW Voltage	I/O V _{CC} sink current = 20 μA	0.9-4.5	0.9-4.5	-	_	0.2	-	0.2	V
V _{OHL}	I/O V _L Output HIGH Voltage	I/O V _L source current = 20 μA	0.9-4.5	0.9-4.5	0.9 * V _L	-	-	0.9 * V _L	-	V
V _{OLL}	I/O V _L Output LOW Voltage	$I/O V_L sink current$ = 20 μA	0.9-4.5	0.9-4.5	-	_	0.2	-	0.2	V
I _{QVCC}	V _{CC} Supply Current		0.9 – 4.5	0.9 – 4.5	-	-	1	-	2.5	μΑ
I _{QVL}	V _L Supply Current	(I/O V _{CC} = float, I/O V _L = 0 V or V _L)	0.9-4.5	0.9-4.5	-	-	1	-	2.5	μA
I _{TS-VCC}	V _{CC} Tristate Output Mode Supply Current	$T_{A} = +25^{\circ}C,$ EN = 0 V (I/O V _{CC} = 0 V or	0.9 – 4.5	0.9 – 4.5	-	-	0.5	-	1.5	μA
I _{TS-VL}	V _L Tristate Output Mode Supply Current	V_{CC} , I/O V_L = float) or (I/O V_{CC} = float, I/O V_L = 0 V or V_L)	0.9 – 4.5	0.9 - 4.5	_	-	0.5	-	1.5	μΑ
I _{OZ}	I/O Tristate Output Mode Leakage Current	$T_A = +25^{\circ}C,$ EN = 0V	0.9-4.5	0.9-4.5	-	_	±1	-	±1.5	μΑ
I _I	Control Pin Input Current	T _A = +25°C	0.9 – 4.5	0.9 - 4.5	-	-	±1	-	±1	μA
I _{OFF}	Power Off Leakage Current	$I/O V_{CC} = 0$ to 4.5V,	0	0	-	-	1	-	1.5	μΑ
		I/O V _L = 0 to 4.5 V	0.9 - 4.5	0	-	-	1	-	1.5	
			0	0.9 - 4.5	-	-	1	-	1.5	ĺ

Normal test conditions are V_I = 0 V, C_{IOVCC} ≤ 15 pF and C_{IOVL} ≤ 15 pF, unless otherwise specified.
 V_{CC} is the supply voltage associated with the I/O V_{CC} port, and V_{CC} ranges from +0.9 V to 4.5 V under normal operating conditions.
 V_L is the supply voltage associated with the I/O V_L port, and V_L ranges from +0.9 V to 4.5 V under normal operating conditions.
 Typical values are for V_{CC} = +2.8 V, V_L = +1.8 V and T_A = +25°C. All units are production tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design.

TIMING CHARACTERISTICS

		Test Conditions ameter (Note 5)	V_{CC} (V) (Note 6)	V_L (V) (Note 7)	-5			
Symbol	Parameter				Min	Typ (Note 8)	Max	Unit
t _{R-VCC}	I/O V _{CC} Rise Time	C _{IOVCC} = 15 pF	0.9-4.5	0.9-4.5	-	-	8.5	nS
			1.8 – 4.5	1.8 – 4.5	-	-	3.5	
t _{F-VCC}	I/O V _{CC} Fall Time	C _{IOVCC} = 15 pF	0.9 - 4.5	0.9 - 4.5	-	-	8.5	nS
			1.8 – 4.5	1.8 – 4.5	-	-	3.5	
t _{R-VL}	I/O V _L Rise Time	C _{IOVL} = 15 pF	0.9 - 4.5	0.9-4.5	-	-	8.5	nS
			1.8 – 4.5	1.8-4.5	-	-	3.5	
t_{F-VL}	I/O V _L Fall Time	C _{IOVL} = 15 pF	0.9 - 4.5	0.9-4.5	-	-	8.5	nS
			1.8 – 4.5	1.8-4.5	-	-	3.5	
Z _{OVCC}	I/O V _{CC} One-Shot Output Impedance	(Note 9)	0.9 1.8	0.9 – 4.5		37 20	-	Ω
Z _{OVL}	I/O V _L One-Shot Out- put Impedance	(Note 9)	4.5 0.9 1.8	0.9 – 4.5		6.0 37 20		Ω
L	Propagation Delay	0 45 -5	4.5	0.0 4.5	-	6.0	-	nS
	(Driving I/O V _{CC})	C _{IOVCC} = 15 pF	0.9 - 4.5 1.8 - 4.5	0.9 - 4.5	-	-	35 10	115
		C _{IOVCC} = 30 pF	1.8 - 4.5 0.9 - 4.5	0.9 - 4.5	-	-	35	
			0.9 – 4.5 1.8 – 4.5	1.8 - 4.5	-	-	10	-
		C _{IOVCC} = 50 pF	1.0 - 4.5	1.0 - 4.5	-	-	37	
		ClOACC = 20 bi	1.0 - 4.5	1.8 - 4.5	-	_	11	1
		C _{IOVCC} = 100 pF	1.2 - 4.5	1.2 - 4.5	_	_	40	
		010000 - 100 bi	1.8 - 4.5	1.8 - 4.5	_	_	13	
PD_VCC-VL	Propagation Delay	C _{IOVL} = 15 pF	0.9 – 4.5	0.9 - 4.5	_	_	35	nS
PD_VCC-VL	(Driving I/O V _L)		1.8 – 4.5	1.8 - 4.5	_	_	10	
		C _{IOVL} = 30 pF	0.9 – 4.5	0.9 – 4.5	_	_	35	
			1.8 – 4.5	1.8 – 4.5	_	_	10	-
		C _{IOVL} = 50 pF	1.0 - 4.5	1.0 – 4.5	-	_	37	
			1.8 – 4.5	1.8 – 4.5	-	_	11	
		C _{IOVL} = 100 pF	1.2 – 4.5	1.2 – 4.5	-	_	40	1
			1.8 – 4.5	1.8 – 4.5	-	_	13	1
t _{SK}	Channel-to-Channel Skew	C _{IOVCC} = 15 pF, C _{IOVL} = 15 pF (Note 9)	0.9-4.5	0.9-4.5	-	-	0.15	nS
I _{IN_PEAK}	Input Driver Maximum Peak Current	EN = V _L ; I/O_V _{CC} = 1 MHz Square Wave, Amplitude = V _{CC} , or I/O_V _L = 1 MHz Square Wave, Amplitude = V _L (Note 9)	0.9 – 4.5	0.9 – 4.5	-	_	5.0	mA

Normal test conditions are V_I = 0 V, C_{IOVCC} ≤ 15 pF and C_{IOVL} ≤ 15 pF, unless otherwise specified.
 V_{CC} is the supply voltage associated with the I/O V_{CC} port, and V_{CC} ranges from +0.9 V to 4.5 V under normal operating conditions.
 V_L is the supply voltage associated with the I/O V_L port, and V_L ranges from +0.9 V to 4.5 V under normal operating conditions.
 Typical values are for V_{CC} = +2.8 V, V_L = +1.8 V and T_A = +25°C. All units are production tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design.
 Ourset test bud to bud the interval.

9. Guaranteed by design.

TIMING CHARACTERISTICS (continued)

						-5	5°C to +125	o°C	
Symbol	Parameter		Test Conditions (Note 10)	V _{CC} (V) (Note 11)	V_L (V) (Note 12)	Min	Typ (Note 13)	Max	Unit
t _{EN-VCC}	I/O_V _{CC} Output Enable Time	t _{PZH}	$C_{IOVCC} = 15 \text{ pF},$ I/O_V _L = V _L	0.9-4.5	0.9 – 4.5	-	-	160	nS
		t _{PZL}	C _{IOVCC} = 15 pF, I/O_V _L = 0 V	0.9-4.5	0.9 – 4.5	-	-	130	
t _{EN-VL}	I/O_V _L Output Enable Time	t _{PZH}	$C_{IOVL} = 15 \text{ pF},$ I/O_V _{CC} = V _{CC}	0.9-4.5	0.9 – 4.5	-	-	160	nS
		t _{PZL}	C _{IOVL} = 15 pF, I/O_V _{CC} = 0 V	0.9-4.5	0.9 – 4.5	-	-	130	
t _{DIS-VCC}	I/O_V _{CC} Output Disable Time	t _{PHZ}	$C_{IOVCC} = 15 \text{ pF},$ I/O_V _L = V _L	0.9-4.5	0.9 – 4.5	-	-	210	nS
		t _{PLZ}	$C_{IOVCC} = 15 \text{ pF},$ I/O_V _L = 0 V	0.9 – 4.5	0.9 – 4.5	-	-	175	
t _{DIS-VL}	I/O_V _L Output Disable Time	t _{PHZ}	C _{IOVL} = 15 pF, I/O_V _{CC} = V _{CC}	0.9 – 4.5	0.9 – 4.5	-	-	210	nS
		t _{PLZ}	C _{IOVL} = 15 pF, I/O_V _{CC} = 0 V	0.9-4.5	0.9 – 4.5	-	-	175	
MDR	Maximum Data Rate		C _{IO} = 15 pF	0.9 – 4.5	0.9-4.5	50	-	-	mbps
l				1.8 – 4.5	1.8 - 4.5	140	-	-	
l			C _{IO} = 30 pF	0.9 – 4.5	0.9-4.5	40	-	-	
l				1.8 – 4.5	1.8 - 4.5	120	-	-	
		-	C _{IO} = 50 pF	1.0 - 4.5	1.0 - 4.5	30	-	-	
				1.8 - 4.5	1.8 – 4.5	100	-	I	
			C _{IO} = 100 pF	1.2 – 4.5	1.2 – 4.5	20	-	-	
L				1.8 – 4.5	1.8 – 4.5	60	-	-	

10. Normal test conditions are V_I = 0 V, C_{IOVCC} ≤ 15 pF and C_{IOVL} ≤ 15 pF, unless otherwise specified.
11. V_{CC} is the supply voltage associated with the I/O V_{CC} port, and V_{CC} ranges from +0.9 V to 4.5 V under normal operating conditions.
12. V_L is the supply voltage associated with the I/O V_L port, and V_L ranges from +0.9 V to 4.5 V under normal operating conditions.
13. Typical values are for V_{CC} = +2.8 V, V_L = +1.8 V and T_A = +25°C. All units are production tested at T_A = +25°C. Limits over the operating temperature range are guaranteed by design.

Symbol	Parameter	Test Conditions	V _{CC} (V) (Note 14)	V_L (V) (Note 15)	Typ (Note 16)	Unit
C_{PD_VL}	$V_L = Input port,$	$C_{Load} = 0, f = 1 MHz,$	0.9	4.5	39	pF
	$V_{CC} = Output Port$	$EN = V_L$ (outputs enabled)	1.5	1.8	20	
			1.8	1.5	17	
			1.8	1.8	14	
			1.8	2.8	13	
			2.5	2.5	14	
			2.8	1.8	13	
			4.5	0.9	19	
V _{CC} = Input port,	$C_{\text{Load}} = 0, f = 1 \text{ MHz},$	0.9	4.5	37	pF	
	V _L = Output Port	$EN = V_L$ (outputs enabled)	1.5	1.8	30	
			1.8	1.5	29	
			1.8	1.8	29	
			1.8	2.8	29	-
			2.5	2.5	30	
			2.8	1.8	29	
			4.5	0.9	19	
C _{PD_VCC}	V _L = Input port,	Input port, Output Port $C_{Load} = 0, f = 1 \text{ MHz},$ EN = V _L (outputs enabled)	0.9	4.5	29	pF
	$V_{CC} = Output Port$		1.5	1.8	29	
			1.8	1.5	29	
			1.8	1.8	29	
			1.8	2.8	29	
			2.5	2.5	30	
			2.8	1.8	29	
			4.5	0.9	35	
	V _{CC} = Input port,	C _{Load} = 0, f = 1 MHz,	0.9	4.5	21	pF
	$V_L = Output Port$	$EN = V_L$ (outputs enabled)	1.5	1.8	18	
			1.8	1.5	18	
			1.8	1.8	14	
			1.8	2.8	13	1
			2.5	2.5	14	1
			2.8	1.8	13	1
			4.5	0.9	30	

14. V_{CC} is the supply voltage associated with the I/O V_{CC} port, and V_{CC} ranges from +0.9 V to 4.5 V under normal operating conditions. 15. V_L is the supply voltage associated with the I/O V_L port, and V_L ranges from +0.9 V to 4.5 V under normal operating conditions. 16. Typical values are at $T_A = +25^{\circ}C$. 17. $C_{PD \ VL}$ and $C_{PD \ VCC}$ are defined as the value of the IC's equivalent capacitance from which the operating current can be calculated for the V_L and V_{CC} power supplies, respectively. $I_{CC} = I_{CC}$ (dynamic) + I_{CC} (static) $\approx I_{CC}$ (operating) $\approx C_{PD} \times V_{CC} \times f_{IN} \times N_{SW}$ where $I_{CC} = I_{CC} \ VCC} + I_{CC \ VL}$ and N_{SW} = total number of outputs switching.

STATIC POWER C	CONSUMPTION	(T _A = +25°C)
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Symbol	Parameter	Test Conditions	V _{CC} (V) (Note 18)	V_L (V) (Note 19)	Typ (Note 20)	Unit
C_{PD_VL}	$V_L = Input port,$	$C_{Load} = 0, f = 1 MHz,$	0.9	4.5	0.01	pF
	$V_{CC} = Output Port$	EN = GND (outputs disabled)	1.5	1.8	0.01	
			1.8	1.5	0.01	
			1.8	1.8	0.01	
			1.8	2.8	0.01	
			2.5	2.5	0.01	
			2.8	1.8	0.01	
			4.5	0.9	0.01	
	V_{CC} = Input port, V_{L} = Output Port	$C_{\text{Load}} = 0, f = 1 \text{ MHz},$	0.9	4.5	0.01	pF
	V _L = Output Port	EN = GND (outputs disabled)	1.5	1.8	0.01	
			1.8	1.5	0.01	
			1.8	1.8	0.01	
			1.8	2.8	0.01	
			2.5	2.5	0.01	_
			2.8	1.8	0.01	
			4.5	0.9	0.01	
C _{PD_VCC}	V _L = Input port,	V_L = Input port, V_C = Output Port C_{Load} = 0, f = 1 MHz, EN = GND (outputs disabled)	0.9	4.5	0.01	pF
	V _{CC} = Output Port		1.5	1.8	0.01	
			1.8	1.5	0.01	
			1.8	1.8	0.01	
			1.8	2.8	0.01	-
			2.5	2.5	0.01	
			2.8	1.8	0.01	
			4.5	0.9	0.01	
	V _{CC} = Input port,	C _{Load} = 0, f = 1 MHz,	0.9	4.5	0.01	pF
	$V_L = Output Port$	EN = GND (outputs disabled)	1.5	1.8	0.01	
			1.8	1.5	0.01	1
			1.8	1.8	0.01	
			1.8	2.8	0.01	
			2.5	2.5	0.01	1
			2.8	1.8	0.01	1
			4.5	0.9	0.01	1

18. V_{CC} is the supply voltage associated with the I/O V_{CC} port, and V_{CC} ranges from +0.9 V to 4.5 V under normal operating conditions. 19. V_L is the supply voltage associated with the I/O V_L port, and V_L ranges from +0.9 V to 4.5 V under normal operating conditions. 20. Typical values are at T_A = +25°C

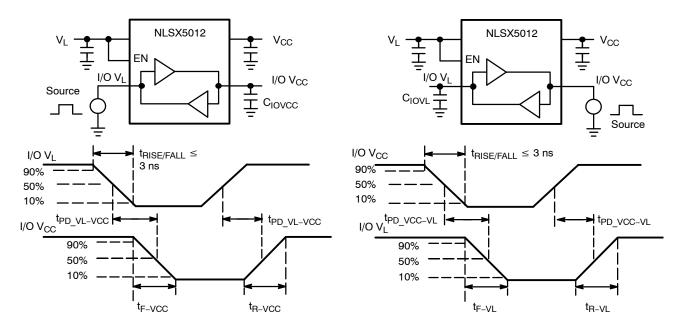
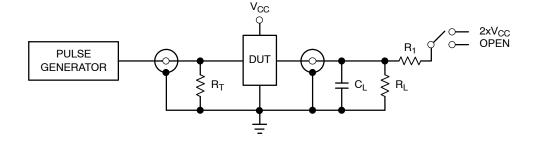


Figure 7. Driving I/O V_L Test Circuit and Timing

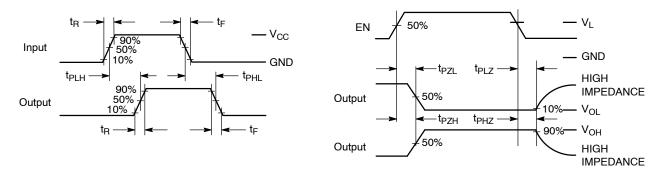
Figure 8. Driving I/O V_{CC} Test Circuit and Timing



Test	Switch	
t _{PZH} , t _{PHZ}	Open	
t _{PZL} , t _{PLZ}	$2 \times V_{CC}$	

 $\begin{array}{l} C_L = 15 \ p\text{F or equivalent (Includes jig and probe capacitance)} \\ R_L = R_1 = 50 \ k\Omega \ \text{or equivalent} \\ R_T = Z_{OUT} \ \text{of pulse generator (typically 50 } \Omega) \end{array}$







IMPORTANT APPLICATIONS INFORMATION

Level Translator Architecture

The NLSX5012 auto-sense translator provides bi-directional logic voltage level shifting to transfer data in multiple supply voltage systems. These level translators have two supply voltages, V_L and V_{CC} , which set the logic levels on the input and output sides of the translator. When used to transfer data from the I/O V_L to the I/O V_{CC} ports, input signals referenced to the V_L supply are translated to output signals with a logic level matched to V_{CC} . In a similar manner, the I/O V_{CC} to I/O V_L translation shifts input signals with a logic level compatible to V_{CC} to an output signal matched to V_L .

The NLSX5012 translator consists of bi-directional channels that independently determine the direction of the data flow without requiring a directional pin. One-shot circuits are used to detect the rising or falling input signals. In addition, the one-shots decrease the rise and fall times of the output signal for high-to-low and low-to-high transitions.

Input Driver Requirements

Auto-sense translators such as the NLSX5012 have a wide bandwidth, but a relatively small DC output current rating. The high bandwidth of the bi-directional I/O circuit is used to quickly transform from an input to an output driver and vice versa. The I/O ports have a modest DC current output specification so that the output driver can be over driven when data is sent in the opposite direction. For proper operation, the input driver to the auto-sense translator should be capable of driving 2 mA of peak output current. The bi-directional configuration of the translator results in both input stages being active for a very short time period. Although the peak current from the input signal circuit is relatively large, the average current is small and consistent with a standard CMOS input stage.

Enable Input (EN)

The NLSX5012 translator has an Enable pin (EN) that provides tri–state operation at the I/O pins. Driving the Enable pin to a low logic level minimizes the power consumption of the device and drives the I/O V_{CC} and I/O

 V_L pins to a high impedance state. Normal translation operation occurs when the EN pin is equal to a logic high signal. The EN pin is referenced to the V_L supply and has Over–Voltage Tolerant (OVT) protection.

Uni-Directional versus Bi-Directional Translation

The NLSX5012 translator can function as a non-inverting uni-directional translator. One advantage of using the translator as a uni-directional device is that each I/O pin can be configured as either an input or output. The configurable input or output feature is especially useful in applications such as SPI that use multiple uni-directional I/O lines to send data to and from a device. The flexible I/O port of the auto sense translator simplifies the trace connections on the PCB.

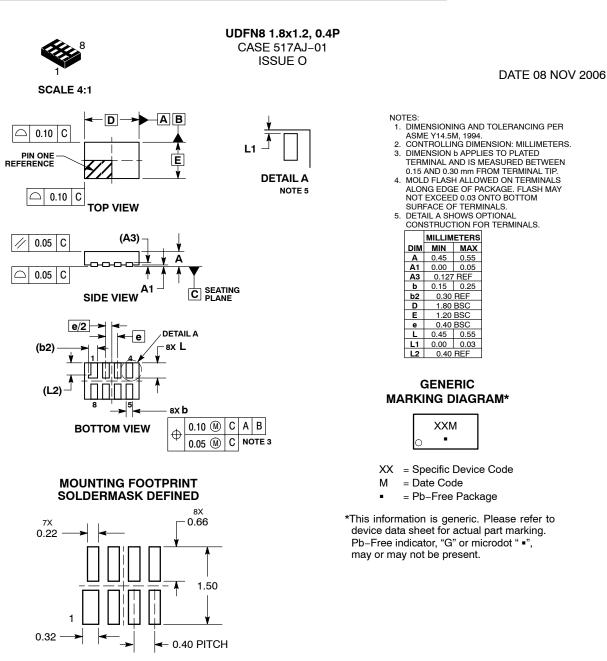
Power Supply Guidelines

The values of the V_L and V_{CC} supplies can be set to anywhere between 0.9 and 4.5 V. Design flexibility is maximized because V_L may be either greater than or less than the V_{CC} supply. In contrast, the majority of the competitive auto sense translators has a restriction that the value of the V_L supply must be equal to less than (V_{CC} – 0.4) V.

The sequencing of the power supplies will not damage the device during power–up operation. In addition, the I/O V_{CC} and I/O V_L pins are in the high impedance state if either supply voltage is equal to 0 V. For optimal performance, 0.01 to 0.1 μ F decoupling capacitors should be used on the V_L and V_{CC} power supply pins. Ceramic capacitors are a good design choice to filter and bypass any noise signals on the voltage lines to the ground plane of the PCB. The noise immunity will be maximized by placing the capacitors as close as possible to the supply and ground pins, along with minimizing the PCB connection traces.

The NLSX5012 translators have a power down feature that provides design flexibility. The output ports are disabled when either power supply is off (V_L or $V_{CC} = 0$ V). This feature causes all of the I/O pins to be in the power saving high impedance state.





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*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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SOIC-8 NB CASE 751-07 **ISSUE AK**

STYLE 1: PIN 1. EMITTER COLLECTOR 2. COLLECTOR З. 4. EMITTER EMITTER 5. 6. BASE 7 BASE 8. EMITTER STYLE 5: PIN 1. DRAIN 2. DRAIN З. DRAIN DRAIN 4. 5. GATE 6. GATE SOURCE 7. 8. SOURCE STYLE 9: PIN 1. EMITTER, COMMON COLLECTOR, DIE #1 COLLECTOR, DIE #2 2. З. EMITTER, COMMON 4. 5. EMITTER, COMMON 6. BASE, DIE #2 BASE, DIE #1 7. 8. EMITTER, COMMON STYLE 13: PIN 1. N.C. 2. SOURCE 3. SOURCE GATE 4. 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 17: PIN 1. VCC 2. V2OUT V10UT З. 4. TXE 5. RXE 6. VFF GND 7. 8. ACC STYLE 21: PIN 1. CATHODE 1 2. CATHODE 2 З. CATHODE 3 CATHODE 4 4. 5. CATHODE 5 6. COMMON ANODE COMMON ANODE 7. 8. CATHODE 6 STYLE 25: PIN 1. VIN 2 N/C З. REXT 4. GND 5. IOUT 6. IOUT 7. IOUT 8. IOUT STYLE 29: BASE, DIE #1 PIN 1. EMITTER, #1 BASE, #2 2. З. EMITTER, #2 4. 5 COLLECTOR, #2 COLLECTOR, #2 6.

STYLE 2: PIN 1. COLLECTOR, DIE, #1 2. COLLECTOR, #1 COLLECTOR, #2 З. 4 COLLECTOR, #2 BASE, #2 5. EMITTER, #2 6. 7 BASE #1 EMITTER, #1 8. STYLE 6: PIN 1. SOURCE 2. DRAIN 3. DRAIN SOURCE 4. SOURCE 5. 6. GATE GATE 7. 8. SOURCE STYLE 10: PIN 1. GROUND BIAS 1 OUTPUT 2. З. GROUND 4. 5. GROUND BIAS 2 INPUT 6. 7. 8. GROUND STYLE 14: PIN 1. N-SOURCE 2. N-GATE P-SOURCE 3 P-GATE 4. 5. P-DRAIN 6. P-DRAIN N-DRAIN 7. 8. N-DRAIN STYLE 18: PIN 1. ANODE 2. ANODE SOURCE 3. GATE 4. 5. DRAIN 6 DRAIN CATHODE 7. 8. CATHODE STYLE 22: PIN 1. I/O LINE 1 2. COMMON CATHODE/VCC 3 COMMON CATHODE/VCC I/O LINE 3 4. 5. COMMON ANODE/GND 6. I/O LINE 4 7. I/O LINE 5 8. COMMON ANODE/GND STYLE 26: PIN 1. GND 2 dv/dt ENABLE З. 4. ILIMIT 5. SOURCE SOURCE 6. SOURCE 7. 8. VCC STYLE 30: PIN 1. DRAIN 1 DRAIN 1 2 GATE 2 З. SOURCE 2 4. SOURCE 1/DRAIN 2 SOURCE 1/DRAIN 2 5. 6.

STYLE 3: PIN 1. DRAIN, DIE #1 2. DRAIN, #1 3. DRAIN, #2 4. DRAIN, #2 5. GATE, #2 6. SOURCE, #2 7. GATE, #1 8. SOURCE, #1
STYLE 7: PIN 1. INPUT 2. EXTERNAL BYPASS 3. THIRD STAGE SOURCE 4. GROUND 5. DRAIN 6. GATE 3 7. SECOND STAGE Vd 8. FIRST STAGE Vd
STYLE 11: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 7. DRAIN 1 8. DRAIN 1
STYLE 15: PIN 1. ANODE 1 2. ANODE 1 3. ANODE 1 4. ANODE 1 5. CATHODE, COMMON 6. CATHODE, COMMON 7. CATHODE, COMMON 8. CATHODE, COMMON
STYLE 19: PIN 1. SOURCE 1 2. GATE 1 3. SOURCE 2 4. GATE 2 5. DRAIN 2 6. MIRROR 2 7. DRAIN 1 8. MIRROR 1
STYLE 23: PIN 1. LINE 1 IN 2. COMMON ANODE/GND 3. COMMON ANODE/GND 4. LINE 2 IN 5. LINE 2 OUT 6. COMMON ANODE/GND 7. COMMON ANODE/GND 8. LINE 1 OUT
STYLE 27: PIN 1. ILIMIT 2. OVLO 3. UVLO 4. INPUT+ 5. SOURCE 6. SOURCE 7. SOURCE 8. DRAIN

DATE 16 FEB 2011

STYLE 4: ANODE ANODE PIN 1. 2. ANODE З. 4. ANODE ANODE 5. 6. ANODE 7 ANODE COMMON CATHODE 8. STYLE 8: PIN 1. COLLECTOR, DIE #1 2. BASE, #1 BASE, #2 З. COLLECTOR, #2 4. COLLECTOR, #2 5. 6. EMITTER, #2 EMITTER, #1 7. 8. COLLECTOR, #1 STYLE 12: PIN 1. SOURCE SOURCE SOURCE 2. 3. 4. GATE 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 16: PIN 1. EMITTER, DIE #1 2. BASE, DIE #1 EMITTER, DIE #2 3 BASE, DIE #2 4. 5. COLLECTOR, DIE #2 6. COLLECTOR, DIE #2 COLLECTOR, DIE #1 7. COLLECTOR, DIE #1 8. STYLE 20: PIN 1. SOURCE (N) GATE (N) SOURCE (P) 2. 3. 4. GATE (P) 5. DRAIN 6. DRAIN DRAIN 7. 8. DRAIN STYLE 24: PIN 1. BASE 2. EMITTER З. COLLECTOR/ANODE COLLECTOR/ANODE 4. 5. CATHODE CATHODE COLLECTOR/ANODE 6. 7. COLLECTOR/ANODE 8. STYLE 28: PIN 1. SW_TO_GND 2. DASIC OFF DASIC_SW_DET З. 4. GND 5. 6. V MON VBULK 7. VBULK 8. VIN

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SOURCE 1/DRAIN 2

7.

8. GATE 1

7.

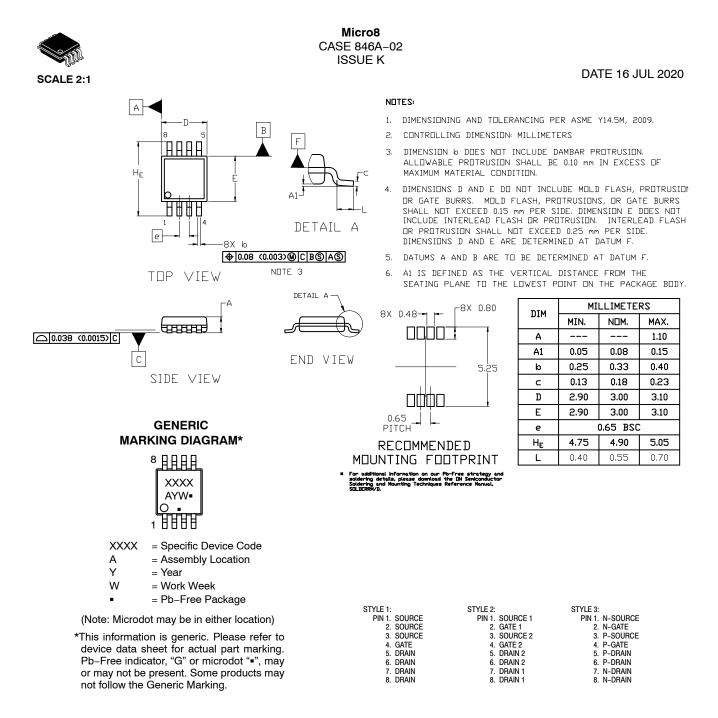
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COLLECTOR, #1

COLLECTOR, #1





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